2SC3944, 2SC3944A

Silicon NPN epitaxial planar type

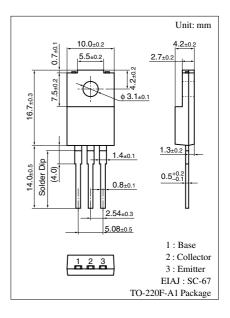
For low-frequency driver and high power amplification Complementary to 2SA1535 and 2SA1535A

■ Features

- \bullet Excelent current I_C characteristics of forward current transfer ratio h_{FE} vs. collector
- High transition frequency f_T
- A complementary pair with 2SA1535 and 2SA1535A, is optimum for the driver-stage of a 60 W to 100 W output amplifier
- Full-pack package which can be installed to the heat sink with one screw

■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter		Symbol	Rating	Unit
Collector to base	2SC3944	V_{CBO}	150	V
voltage	2SC3944A		180	
Collector to	2SC3944	V _{CEO}	150	V
emitter voltage	2SC3944A		180	
Emitter to base voltage		V_{EBO}	5	V
Peak collector current		I_{CP}	1.5	A
Collector current		I_{C}	1	A
Collector power	$T_C = 25^{\circ}C$	P _C	15	W
dissipation	$T_a = 25^{\circ}C$		2.0	
Junction temperature		T _j	150	°C
Storage temperature		T_{stg}	-55 to +150	°C



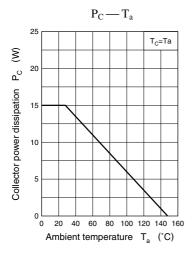
■ Electrical Characteristics $T_C = 25$ °C

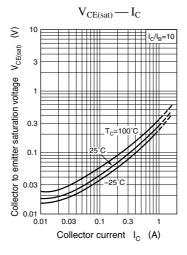
Paramete	r	Symbol	Conditions	Min	Тур	Max	Unit
Collector cutoff	2SC3944	I_{CBO}	$V_{CB} = 150 \text{ V}, I_E = 0$			10	μΑ
current	2SC3944A		$V_{CB} = 180 \text{ V}, I_E = 0$			10	
Collector to base	2SC3944	V_{CEO}	$I_C = 1 \text{ mA}, I_B = 0$	150			V
voltage	2SC3944A			180			
Emitter cutoff current		V_{EBO}	$I_E = 10 \ \mu A, \ I_C = 0$	5			V
Forward current transfer ratio		h _{FE1} *	$V_{CE} = 10 \text{ V}, I_{C} = 150 \text{ mA}$	95	160	220	
		h _{FE2}	$V_{CE} = 5 \text{ V}, I_{C} = 500 \text{ mA}$	50	100		
Collector to emitter saturation voltage		V _{CE(sat)}	$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		0.5	2	V
Base to emitter saturation voltage		V _{BE(sat)}	$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		1	2	V
Transition frequency		f_T	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 10 \text{ MHz}$		200		MHz
Collector output capacitance		C _{ob}	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		30	50	pF

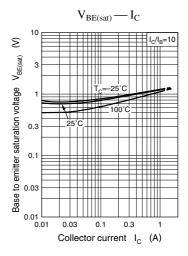
Note) *: Rank classification

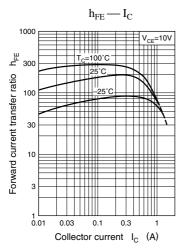
Rank	Q	R			
h _{FE1}	95 to 155	130 to 220			

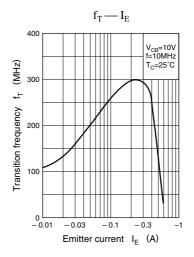
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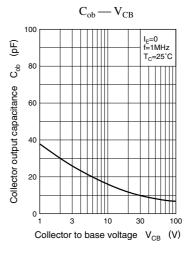


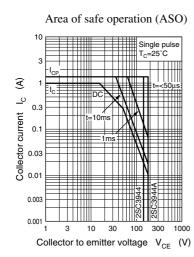












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